DESCRIPTION

The AM047NS08T is available in the TO-220 Package.

VDSS	RDSON	ID
80V	4.7mΩ	117A

FEATURES

- 80V, 117A
  $R_{DS(ON)}$ Typ. = 4.7mΩ @ V_{GS} = 10V
- Advanced Split Gate Trench Technology
- Excellent $R_{DS(ON)}$ and Low Gate Charge

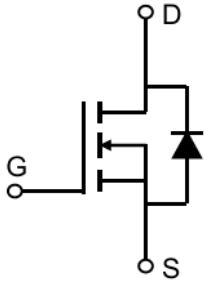
APPLICATIONS

- Load Switch
- PWM Application
- Power Management

ORDERING INFORMATION

Package Type	Part Number	
TO-220 SPQ: 50pcs /Tube	T3	AM047NS08T3VU
Note	V: Halogen free Package U: Tube Package	
AiT provides all RoHS products		

PIN DESCRIPTION



Pin#	Symbol	Function
1	G	Gate
2	D	Drain
3	S	Source

ABSOLUTE MAXIMUM RATINGS

T_J=25℃, unless otherwise Noted

V_{DS}, Drain-to-Source Voltage		80V
V_{GS}, Gate-to-Source Voltage		±20V
I_D, Continue Drain Current	T_C=25℃	117A
	T_C=100℃	70.2A
I_{DM}, Pulsed Drain Current (1)		468A
E_{AS}, Single Pulse Avalanche Energy (2)		272mJ
P_D, Power Dissipation	T_C=25℃	142W
$R_{\theta JC}$, Thermal Resistance, Junction to Case		0.88℃/W
T_J, Operating Junction Temperature Range		-55℃~+150℃
T_{STG}, Storage Temperature Range		-55℃~+150℃

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

(1) Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
(2) EAS condition: Starting TJ=25°C, VDD=50V, VG=10V, RG=25ohm, L=0.5mH, IAS=47A

ELECTRICAL CHARACTERISTICS

T_J = 25°C, unless otherwise Noted

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Off Characteristic						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V, I_D=250μA	80	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}= 80V, V_{GS}=0V	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	V_{DS}= 0V, V_{GS}=±20V	-	-	±100	nA
On Characteristic						
Static Drain-Source ON-Resistance *	$R_{DS(ON)}$	V_{GS}=10V, I_D=20A	-	4.7	6.1	mΩ
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=250μA	2	3	4	V
Dynamic Characteristic						
Input Capacitance	C_{iss}	V_{DS}=40V, V_{GS}=0V, f=1MHz	-	3468	-	pF
Output Capacitance	C_{oss}		-	660	-	
Reverse Transfer Capacitance	C_{rss}		-	13	-	
Total Gate Charge	Q_G	V_{DS}= 40V, I_D=55A, V_{GS}= 0V ~ 10V	-	48	-	nC
Gate-Source charge	Q_{gS}		-	15	-	
Gate-Drain charge	Q_{gd}		-	14	-	
Switching Characteristic						
Turn-On Delay Time	$t_{d(on)}$	V_{DD}= 40V, R_{GEN}=1.6Ω V_{GS}= 10V, I_D=55A	-	16	-	ns
Rise Time	t_r		-	15	-	
Turn-Off Delay Time	$t_{d(off)}$		-	40		
Fall Time	t_f		-	12	-	
Drain-Source Diode Characteristics and Max Ratings						
Maximum Continuous Drain to Source Diode Forward Current	I_S	-	-	-	117	A
Maximum Pulsed Drain to Source Diode Forward Current	I_{SM}	-	-	-	468	A
Drain to Source Diode Forward Voltage	V_{SD}	V_{GS}=0V, I_S=20A	-	-	1.20	V
Body Diode Reverse Recovery Time	t_{rr}	I_F=30A, di/dt=100A/μs	-	40	-	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	165	-	nC

* Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%.

TYPICAL PERFORMANCE CHARACTERISTICS

Fig 1. Gate Charge Test Circuit & Waveform

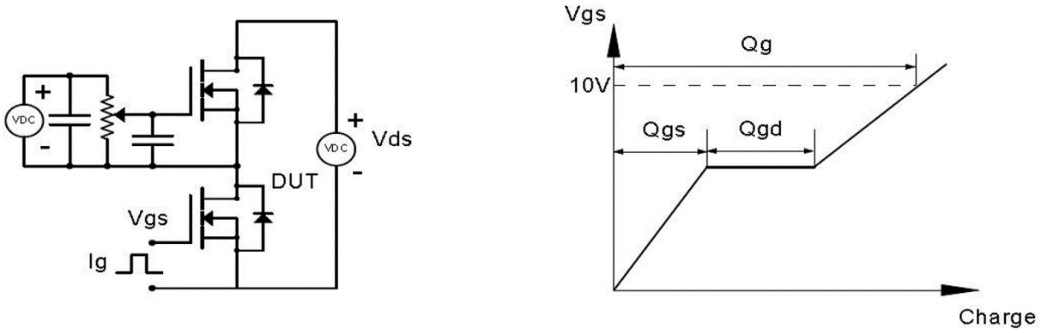


Fig 2. Resistive Switching Test Circuit & Waveforms

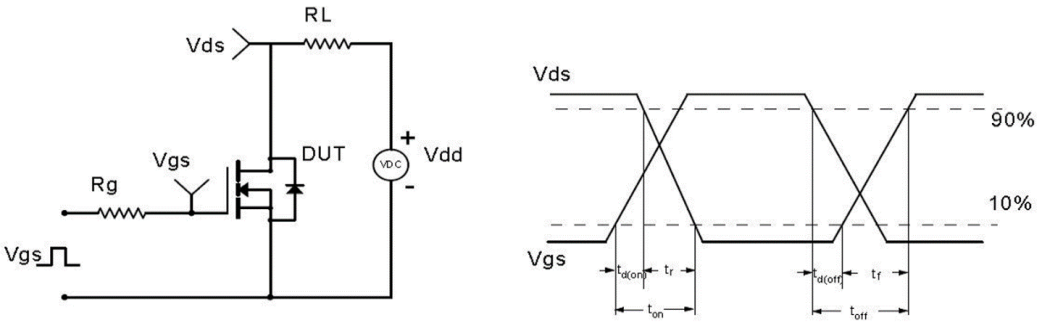


Fig 3. Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

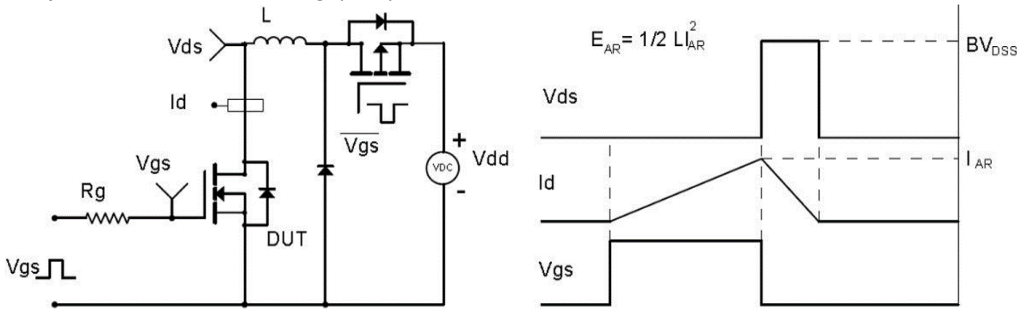
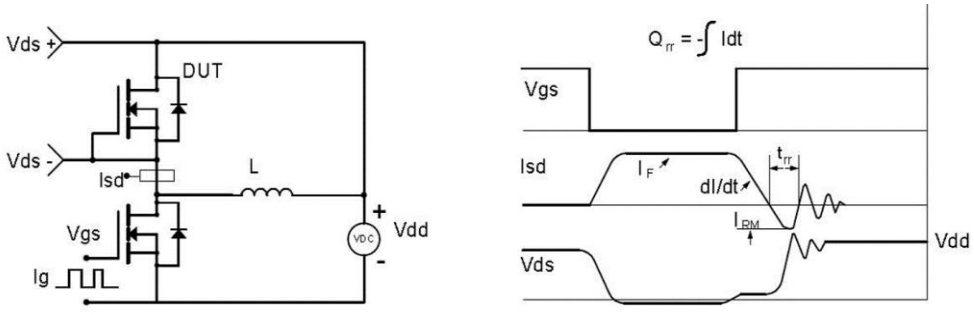
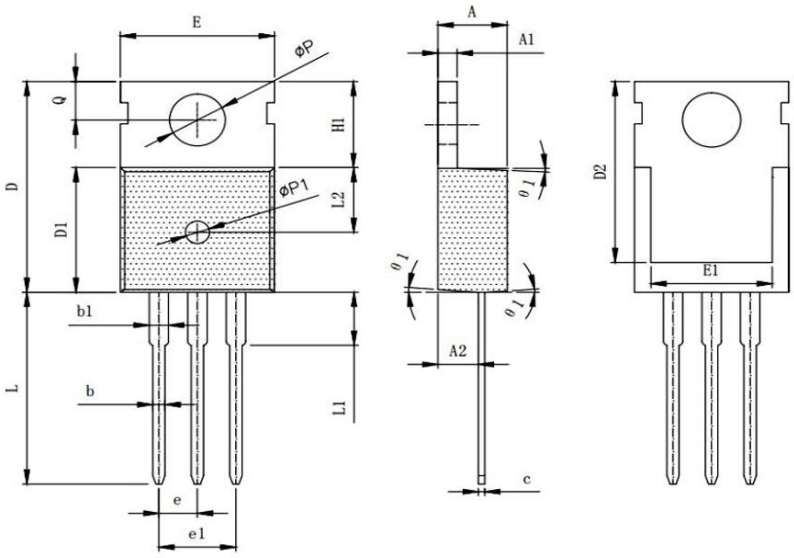


Fig 4. Diode Recovery Test Circuit & Waveforms



PACKAGE INFORMATION

Dimension in TO-220(Unit: mm)



Symbol	Millimeter	
	Min.	Max.
A	4.400	4.600
A1	1.250	1.350
A2	2.300	2.500
b	0.700	0.900
b1	1.250	1.450
c	0.400	0.600
D	15.500	16.100
D1	9.100	9.300
D2	12.730	12.930
e	2.540 BSC.	
e1	5.080 BSC.	
E	9.700	10.200
E1	7.600	8.400
H1	6.300	6.800
L	12.750	13.500
L1	-	3.100
L2	4.300	4.900
Q	2.700	2.900
φP	3. 500	3.700
φP1	1.400	1.600
θ1	2°	6°

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